- **Single-Rail Outputs on 'LS399**

- **Selects One of Two 4-Bit Data Sources and Stores Data Synchronously with System Clock**

- **Applications:**

  Dual Source for Operands and Constants in Arithmetic Processor; Can Release Processor Register Files for Acquiring New Data

  Implement Separate Registers Capable of Parallel Exchange of Contents Yet Retain External Load Capability

  Universal Type Register for Implementing Various Shift Patterns: Even Has Compound Left-Right Capabilities

description

This monolithic quadruple two-input multiplexer with storage provides essentially the equivalent functional capabilities of two separate MSI functions (SN54LS157/SN74LS157 and SN54LS175/SN74LS175) in a single 16-pin package.

When the word-select input is low, word 1 (A1, B1, C1, D1) is applied to the flip-flops. A high input to word select will cause the selection of word 2 (A2, B2, C2, D2). The selected word is clocked to the output terminals on the positive-going edge of the clock pulse.
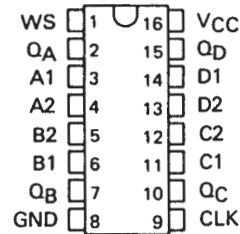
Typical power dissipation is 37 milliwatts. The SN54LS399 is characterized for operation over the full military range of $-55\,°C$ to $125\,°C$. The SN74LS399 is characterized for operation from $0\,°C$ to $70\,°C$.

FUNCTION TABLE

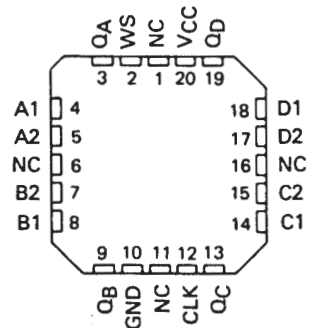| INPUTS		OUTPUTS			
WORD SELECT	CLOCK	Q_A	Q_B	Q_C	Q_D
L	↑	a1	b1	c1	d1
H	↑	a2	b2	c2	d2
X	L	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}

SN54LS399 . . . J OR W PACKAGE
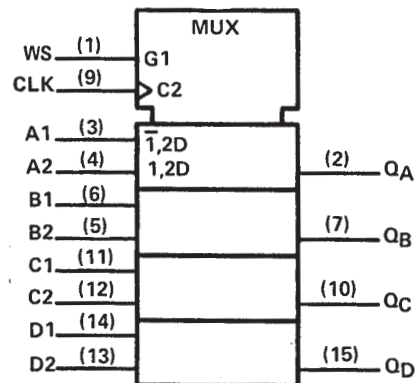SN74LS399 . . . D OR N PACKAGE
(TOP VIEW)

SN54LS399 . . . FK PACKAGE
(TOP VIEW)
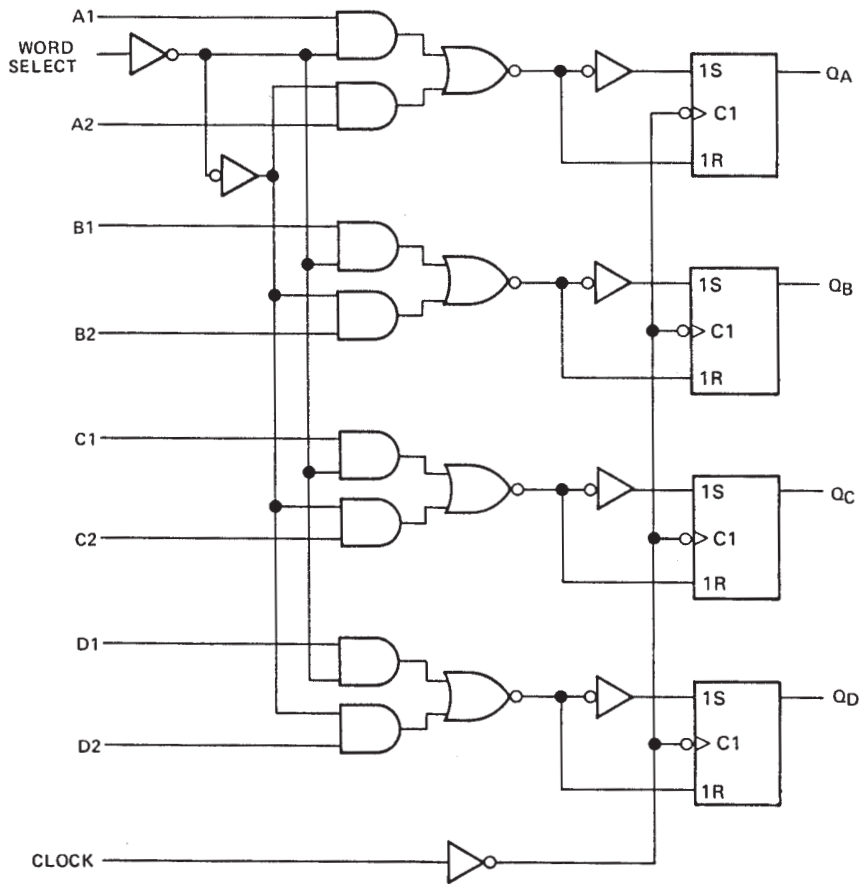

NC – No internal connection

logic symbol[†]

[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

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TEXAS INSTRUMENTS

logic diagram (positive logic)

schematics of inputs and outputs
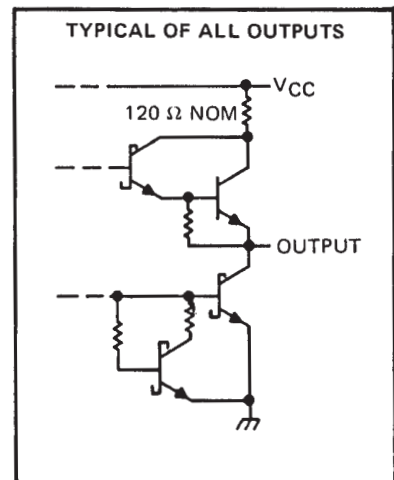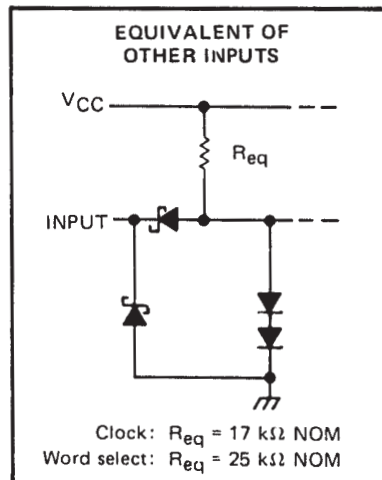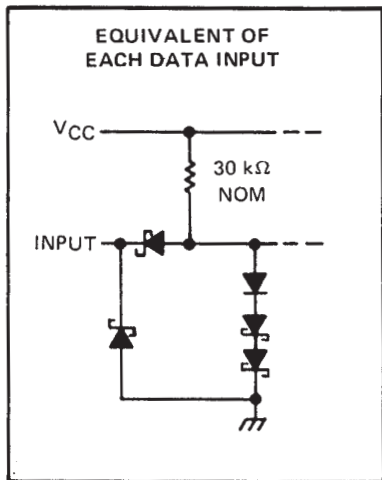
EQUIVALENT OF EACH DATA INPUT

EQUIVALENT OF OTHER INPUTS

Clock: R_{eq} = 17 kΩ NOM
Word select: R_{eq} = 25 kΩ NOM

TYPICAL OF ALL OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . 7 V
Input voltage . . . . 7 V
Operating free-air temperature range: SN54LS399 . . . . −55°C to 125°C
                             SN74LS399 . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

		SN54LS399			SN74LS399			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Width of clock pulse, high or low level, t_W		20			20			ns
Setup time, t_{su}	Data	25			25			ns
	Word select	45			45			
Hold time, t_h	Data	0			0			ns
	Word select	0			0			
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS[†]		SN54LS399			SN74LS399			UNIT
				MIN	TYP[‡]	MAX	MIN	TYP[‡]	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL}max	I_{OH} = −400 μA	2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL}max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 7 V			0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V			−0.4			−0.4	mA
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CC}	Supply current	V_{CC} = MAX,	See Note 2		7.3	13		7.3	13	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.
[§] Not more than one output should be shorted at a time, duration of the short-circuit should not exceed one second.
NOTE 2: With all outputs open and all inputs except clock low, I_{CC} is measured after applying a momentary 4.5 V, followed by ground, to the clock input.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 15 pF,	R_L = 2 kΩ, See Note 3		18	27	ns
t_{PHL}	Propagation delay time, high-to-low-level output				21	32	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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